## ADC08060

8-Bit, 20 MSPS to 60 MSPS, $1.3 \mathrm{~mW} / \mathrm{MSPS}$ A/D Converter General Description
The ADC08060 is a low-power, 8-bit, monolithic analog-todigital converter with an on-chip track-and-hold circuit. Optimized for low cost, low power, small size and ease of use, this product operates at conversion rates of 20 MSPS to 70 MSPS with outstanding dynamic performance over its full operating range while consuming just 1.3 mW per MHz of clock frequency. That's just 78 mW of power at 60 MSPS. Raising the PD pin puts the ADC08060 into a Power Down mode where it consumes just 1 mW .
The unique architecture achieves 7.5 Effective Bits with 25 MHz input frequency. The excellent DC and AC characteristics of this device, together with its low power consumption and single +3 V supply operation, make it ideally suited for many imaging and communications applications, including use in portable equipment. Furthermore, the ADC08060 is resistant to latch-up and the outputs are short-circuit proof. The top and bottom of the ADC08060's reference ladder are available for connections, enabling a wide range of input possibilities. The digital outputs are TTL/CMOS compatible with a separate output power supply pin to support interfacing with 3 V or 2.5 V logic. The digital inputs (CLK and PD) are TTL/CMOS compatible.
The ADC08060 is offered in a 24 -lead plastic package (TSSOP) and is specified over the industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.

## Features

- Single-ended input
- Internal sample-and-hold function
- Low voltage (single +3 V ) operation
- Small package
- Power-down feature


## Key Specifications

- Resolution

8 bits

- Maximum sampling frequency

60 MSPS (min)

- DNL
0.4 LSB (typ)
- ENOB
7.5 bits (typ) at $\mathrm{f}_{\mathrm{IN}}=25 \mathrm{MHz}$
-60 dB (typ)
- THD

Guaranteed

- No missing codes
- Power Consumption
- Operating
1.3 mW/MSPS (typ)
- Power down


## Applications

- Digital imaging systems
- Communication systems
- Portable instrumentation
- Viterbi decoders
- Set-top boxes


## Pin Configuration



Ordering Information

| ADC08060CIMT | TSSOP |
| :---: | :--- |
| ADC08060CIMTX | TSSOP (tape and reel) |

## Block Diagram



20006202

## Pin Descriptions and Equivalent Circuits

Pin No. | Symbol |
| :---: |

Pin Descriptions and Equivalent Circuits (Continued)

| Pin No. | Symbol | Description |  |
| :---: | :---: | :---: | :--- |
| 23 | DO-D7 |  |  |

## Absolute Maximum Ratings (Notes 1, <br> 2) <br> If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

| Supply Voltage $\left(\mathrm{V}_{\mathrm{A}}\right)$ | 3.8 V |
| :--- | ---: |
| Driver Supply Voltage ( $\mathrm{DR} \mathrm{V}_{\mathrm{D}}$ ) | $\mathrm{V}_{\mathrm{A}}+0.3 \mathrm{~V}$ |
| Voltage on Any Input or Output Pin | -0.3 V to $\mathrm{V}_{\mathrm{A}}$ |
| Reference Voltage $\left(\mathrm{V}_{\mathrm{RT}}, \mathrm{V}_{\mathrm{RB}}\right)$ | $\mathrm{V}_{\mathrm{A}}$ to AGND |
| CLK, $\overline{\mathrm{OE}}$ Voltage Range | -0.3 V to |
|  | $\left(\mathrm{V}_{\mathrm{A}}+0.3 \mathrm{~V}\right)$ |
| Digital Output Voltage $\left(\mathrm{V}_{\mathrm{OH}}, \mathrm{V}_{\mathrm{OL}}\right)$ | DR GND to $\mathrm{DR} \mathrm{V}_{\mathrm{D}}$ |
| Input Current at Any Pin (Note 3) | $\pm 25 \mathrm{~mA}$ |
| Package Input Current (Note 3) | $\pm 50 \mathrm{~mA}$ |
| Power Dissipation at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | See (Note 4) |
| ESD Susceptibility (Note 5) |  |
| $\quad$ Human Body Model | 2500 V |
| Machine Model | 250 V |

Soldering Temperature, Infrared,
10 seconds (Note 6) $235^{\circ} \mathrm{C}$

Storage Temperature $\quad-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Operating Ratings (Notes 1, 2)

| Operating Temperature Range | $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ |
| :--- | ---: |
| Supply Voltage $\left(\mathrm{V}_{\mathrm{A}}\right)$ | +2.7 V to +3.6 V |
| Driver Supply Voltage (DR $\left.\mathrm{V}_{\mathrm{D}}\right)$ | +2.4 V to $\mathrm{V}_{\mathrm{A}}$ |
| Ground Difference IGND - DR GNDI | 0 V to 300 mV |
| Upper Reference Voltage $\left(\mathrm{V}_{\mathrm{RT}}\right)$ | 1.0 V to $\left(\mathrm{V}_{\mathrm{A}}+0.1 \mathrm{~V}\right)$ |
| Lower Reference Voltage $\left(\mathrm{V}_{\mathrm{RB}}\right)$ | 0 V to $\left(\mathrm{V}_{\mathrm{RT}}-1.0 \mathrm{~V}\right)$ |
| $\mathrm{V}_{\mathrm{IN}}$ Voltage Range | $\mathrm{V}_{\mathrm{RB}}$ to $\mathrm{V}_{\mathrm{RT}}$ |

## Converter Electrical Characteristics

The following specifications apply for $\mathrm{V}_{\mathrm{A}}=\mathrm{DR} \mathrm{V}_{\mathrm{D}}=+3.0 \mathrm{~V}_{\mathrm{DC}}, \mathrm{V}_{\mathrm{RT}}=+1.9 \mathrm{~V}, \mathrm{~V}_{\mathrm{RB}}=0.3 \mathrm{~V}, \mathrm{C}_{\mathrm{L}}=10 \mathrm{pF}, \mathrm{f}_{\mathrm{CLK}}=60 \mathrm{MHz}$ at $50 \%$ duty cycle. Boldface limits apply for $T_{A}=T_{\text {min }}$ to $T_{\text {MAX }}$ : all other limits $T_{A}=25^{\circ} \mathrm{C}$ (Notes 7, 8)

| Symbol | Parameter | Conditions | Typical <br> (Note 9) | Limits (Note 9) | Units (Limits) |
| :---: | :---: | :---: | :---: | :---: | :---: |
| DC ACCURACY |  |  |  |  |  |
| INL | Integral Non-Linearity |  | $\pm 0.5$ | $\pm 1.3$ | LSB (max) |
| DNL | Differential Non-Linearity |  | $\pm 0.4$ | $\begin{aligned} & \hline+1.0 \\ & -0.9 \end{aligned}$ | $\begin{aligned} & \text { LSB (max) } \\ & \text { LSB (min) } \end{aligned}$ |
|  | Missing Codes |  |  | 0 | (max) |
| FSE | Full Scale Error |  | 18 | $\pm 28$ | mV (max) |
| ZSE | Zero Scale Offset Error |  | 26 | $\pm 35$ | mV (max) |

ANALOG INPUT AND REFERENCE CHARACTERISTICS

| $\mathrm{V}_{\text {IN }}$ | Input Voltage |  |  | 1.6 | $\mathrm{V}_{\text {RB }}$ | V (min) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | $\mathrm{V}_{\text {RT }}$ | V (max) |
| $\mathrm{C}_{\text {IN }}$ | $\mathrm{V}_{\text {IN }}$ Input Capacitance | $\mathrm{V}_{\text {IN }}=0.75 \mathrm{~V}+0.5$ | (CLK LOW) | 3 |  | pF |
|  |  | Vrms | (CLK HIGH) | 4 |  | pF |
| $\mathrm{R}_{\text {IN }}$ | $\mathrm{R}_{\text {IN }}$ Input Resistance |  |  | $>1$ |  | $\mathrm{M} \Omega$ |
| BW | Full Power Bandwidth |  |  | 200 |  | MHz |
| $\mathrm{V}_{\mathrm{RT}}$ | Top Reference Voltage |  |  | 1.9 | $\mathrm{V}_{\text {A }}$ | V (max) |
|  |  |  |  |  | 1.0 | $V$ (min) |
| $\mathrm{V}_{\text {RB }}$ | Bottom Reference Voltage |  |  | 0.3 | $\mathrm{V}_{\text {RT }}-1.0$ | V (max) |
|  |  |  |  |  | 0 | V (min) |
| $\mathrm{V}_{\text {RT }}$ - | Reference Delta |  |  | 16 | 1.0 | V (min) |
| $\mathrm{V}_{\mathrm{RB}}$ |  |  |  |  | 2.3 | V (max) |
| $\mathrm{R}_{\text {REF }}$ | Reference Ladder Resistance | $\mathrm{V}_{\mathrm{RT}}$ to $\mathrm{V}_{\mathrm{RB}}$ |  | 220 | 150 | $\Omega$ (min) |
|  |  |  |  |  | 300 | $\Omega$ (max) |
| $\mathrm{I}_{\text {REF }}$ | Reference Ladder Current |  |  | 73 | 5.3 | mA (min) |
|  |  |  |  |  | 10.6 | mA (max) |

CLK, PD DIGITAL INPUT CHARACTERISTICS

| $\mathrm{V}_{\mathrm{IH}}$ | Logical High Input Voltage | $\mathrm{DR} \mathrm{V}_{\mathrm{D}}=\mathrm{V}_{\mathrm{A}}=3.3 \mathrm{~V}$ |  | $\mathbf{2 . 0}$ | $\mathrm{~V}(\mathrm{~min})$ |
| :---: | :--- | :--- | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{IL}}$ | Logical Low Input Voltage | $\mathrm{DR} \mathrm{V}_{\mathrm{D}}=\mathrm{V}_{\mathrm{A}}=2.7 \mathrm{~V}$ |  | $\mathbf{0 . 8}$ | $\mathrm{~V}(\mathrm{max})$ |
| $\mathrm{I}_{\mathrm{IH}}$ | Logical High Input Current | $\mathrm{V}_{\mathrm{IH}}=\mathrm{DR} \mathrm{V}_{\mathrm{D}}=\mathrm{V}_{\mathrm{A}}=3.3 \mathrm{~V}$ | 10 |  | nA |

## Converter Electrical Characteristics <br> (Continued)

The following specifications apply for $\mathrm{V}_{\mathrm{A}}=\mathrm{DR} \mathrm{V}_{\mathrm{D}}=+3.0 \mathrm{~V}_{\mathrm{DC}}, \mathrm{V}_{\mathrm{RT}}=+1.9 \mathrm{~V}, \mathrm{~V}_{\mathrm{RB}}=0.3 \mathrm{~V}, \mathrm{C}_{\mathrm{L}}=10 \mathrm{pF}, \mathrm{f}_{\mathrm{CLK}}=60 \mathrm{MHz}$ at $50 \%$ duty cycle. Boldface limits apply for $T_{A}=T_{\text {MIN }}$ to $T_{\text {MAX }}$ : all other limits $T_{A}=25^{\circ} \mathrm{C}$ (Notes 7, 8)

| Symbol | Parameter | Conditions | Typical (Note 9) | Limits (Note 9) | Units (Limits) |
| :---: | :---: | :---: | :---: | :---: | :---: |
| CLK, PD DIGITAL INPUT CHARACTERISTICS |  |  |  |  |  |
| $\mathrm{I}_{\text {IL }}$ | Logical Low Input Current | $\mathrm{V}_{\mathrm{IL}}=0 \mathrm{~V}, \mathrm{DR} \mathrm{V}_{\mathrm{D}}=\mathrm{V}_{\mathrm{A}}=2.7 \mathrm{~V}$ | -50 |  | nA |
| $\mathrm{C}_{\text {IN }}$ | Logic Input Capacitance |  | 3 |  | pF |
| DIGITAL OUTPUT CHARACTERISTICS |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{OH}}$ | High Level Output Voltage | $\mathrm{V}_{\mathrm{A}}=\mathrm{DR} \mathrm{V}_{\mathrm{D}}=2.7 \mathrm{~V}, \mathrm{I}_{\mathrm{OH}}=-400 \mu \mathrm{~A}$ | 2.6 | 2.4 | V (min) |
| $\mathrm{V}_{\mathrm{OL}}$ | Low Level Output Voltage | $\mathrm{V}_{\mathrm{A}}=\mathrm{DR} \mathrm{V}_{\mathrm{D}}=2.7 \mathrm{~V}, \mathrm{I}_{\mathrm{OL}}=1.0 \mathrm{~mA}$ | 0.4 | 0.5 | V (max) |
| DYNAMIC PERFORMANCE |  |  |  |  |  |
| ENOB | Effective Number of Bits | $\mathrm{f}_{\mathrm{IN}}=4.4 \mathrm{MHz}, \mathrm{V}_{\text {IN }}=\mathrm{FS}-0.25 \mathrm{~dB}$ | 7.6 |  | Bits |
|  |  | $\mathrm{f}_{\text {IN }}=10 \mathrm{MHz}, \mathrm{V}_{\text {IN }}=\mathrm{FS}-0.25 \mathrm{~dB}$ | 7.6 | 7.1 | Bits (min) |
|  |  | $\mathrm{f}_{\mathrm{IN}}=25 \mathrm{MHz}, \mathrm{V}_{\text {IN }}=\mathrm{FS}-0.25 \mathrm{~dB}$ | 7.5 |  | Bits |
|  |  | $\mathrm{f}_{\text {IN }}=29 \mathrm{MHz}, \mathrm{V}_{\text {IN }}=\mathrm{FS}-0.25 \mathrm{~dB}$ | 7.4 |  | Bits |
| SINAD | Signal-to-Noise \& Distortion | $\mathrm{f}_{\text {IN }}=4.4 \mathrm{MHz}, \mathrm{V}_{\text {IN }}=\mathrm{FS}-0.25 \mathrm{~dB}$ | 47 |  | dB |
|  |  | $\mathrm{f}_{\mathrm{IN}}=10 \mathrm{MHz}, \mathrm{V}_{\text {IN }}=\mathrm{FS}-0.25 \mathrm{~dB}$ | 47 | 44.5 | dB (min) |
|  |  | $\mathrm{f}_{\mathrm{IN}}=25 \mathrm{MHz}, \mathrm{V}_{\text {IN }}=\mathrm{FS}-0.25 \mathrm{~dB}$ | 47 |  | dB |
|  |  | $\mathrm{f}_{\mathrm{IN}}=29 \mathrm{MHz}, \mathrm{V}_{\text {IN }}=\mathrm{FS}-0.25 \mathrm{~dB}$ | 46 |  | dB |
| SNR | Signal-to-Noise Ratio | $\mathrm{f}_{\mathrm{IN}}=4.4 \mathrm{MHz}, \mathrm{V}_{\text {IN }}=\mathrm{FS}-0.25 \mathrm{~dB}$ | 47 |  | dB |
|  |  | $\mathrm{f}_{\text {IN }}=10 \mathrm{MHz}, \mathrm{V}_{\text {IN }}=\mathrm{FS}-0.25 \mathrm{~dB}$ | 47 | 44.6 | dB (min) |
|  |  | $\mathrm{f}_{\mathrm{IN}}=25 \mathrm{MHz}, \mathrm{V}_{\text {IN }}=\mathrm{FS}-0.25 \mathrm{~dB}$ | 47 |  | dB |
|  |  | $\mathrm{f}_{\mathrm{IN}}=29 \mathrm{MHz}, \mathrm{V}_{\text {IN }}=\mathrm{FS}-0.25 \mathrm{~dB}$ | 46 |  | dB |
| SFDR | Spurious Free Dynamic Range | $\mathrm{f}_{\text {IN }}=4.4 \mathrm{MHz}, \mathrm{V}_{\text {IN }}=\mathrm{FS}-0.25 \mathrm{~dB}$ | 64 |  | dBc |
|  |  | $\mathrm{f}_{\mathrm{IN}}=10 \mathrm{MHz}, \mathrm{V}_{\text {IN }}=\mathrm{FS}-0.25 \mathrm{~dB}$ | 63 |  | dBc |
|  |  | $\mathrm{f}_{\mathrm{IN}}=25 \mathrm{MHz}, \mathrm{V}_{\text {IN }}=\mathrm{FS}-0.25 \mathrm{~dB}$ | 60 |  | dBc |
|  |  | $\mathrm{f}_{\mathrm{IN}}=29 \mathrm{MHz}, \mathrm{V}_{\text {IN }}=\mathrm{FS}-0.25 \mathrm{~dB}$ | 54 |  | dBc |
| THD | Total Harmonic Distortion | $\mathrm{f}_{\text {IN }}=4.4 \mathrm{MHz}, \mathrm{V}_{\text {IN }}=\mathrm{FS}-0.25 \mathrm{~dB}$ | -64 |  | dBc |
|  |  | $\mathrm{f}_{\mathrm{IN}}=10 \mathrm{MHz}, \mathrm{V}_{\text {IN }}=\mathrm{FS}-0.25 \mathrm{~dB}$ | -63 |  | dBc |
|  |  | $\mathrm{f}_{\mathrm{IN}}=25 \mathrm{MHz}, \mathrm{V}_{\text {IN }}=\mathrm{FS}-0.25 \mathrm{~dB}$ | -57 |  | dBc |
|  |  | $\mathrm{f}_{\text {IN }}=29 \mathrm{MHz}, \mathrm{V}_{\text {IN }}=\mathrm{FS}-0.25 \mathrm{~dB}$ | -54 |  | dBc |
| HD2 | 2nd Harmonic Distortion | $\mathrm{f}_{\text {IN }}=4.4 \mathrm{MHz}, \mathrm{V}_{\text {IN }}=\mathrm{FS}-0.25 \mathrm{~dB}$ | -70 |  | dBc |
|  |  | $\mathrm{f}_{\mathrm{IN}}=10 \mathrm{MHz}, \mathrm{V}_{\text {IN }}=\mathrm{FS}-0.25 \mathrm{~dB}$ | -65 |  | dBc |
|  |  | $\mathrm{f}_{\mathrm{IN}}=25 \mathrm{MHz}, \mathrm{V}_{\text {IN }}=\mathrm{FS}-0.25 \mathrm{~dB}$ | -64 |  | dBc |
|  |  | $\mathrm{f}_{\mathrm{IN}}=29 \mathrm{MHz}, \mathrm{V}_{\text {IN }}=\mathrm{FS}-0.25 \mathrm{~dB}$ | -54 |  | dBc |
| HD3 | 3rd Harmonic Distortion | $\mathrm{f}_{\mathrm{IN}}=4.4 \mathrm{MHz}, \mathrm{V}_{\text {IN }}=\mathrm{FS}-0.25 \mathrm{~dB}$ | -72 |  | dBc |
|  |  | $\mathrm{f}_{\text {IN }}=10 \mathrm{MHz}, \mathrm{V}_{\text {IN }}=\mathrm{FS}-0.25 \mathrm{~dB}$ | -70 |  | dBc |
|  |  | $\mathrm{f}_{\mathrm{IN}}=25 \mathrm{MHz}, \mathrm{V}_{\text {IN }}=\mathrm{FS}-0.25 \mathrm{~dB}$ | -68 |  | dBc |
|  |  | $\mathrm{f}_{\text {IN }}=29 \mathrm{MHz}, \mathrm{V}_{\text {IN }}=\mathrm{FS}-0.25 \mathrm{~dB}$ | -65 |  | dBc |
| IMD | Intermodulation Distortion | $\begin{aligned} & \mathrm{f}_{1}=11 \mathrm{MHz}, \mathrm{~V}_{\mathrm{IN}}=\mathrm{FS}-6.25 \mathrm{~dB} \\ & \mathrm{f}_{2}=12 \mathrm{MHz}, \mathrm{~V}_{\mathrm{IN}}=\mathrm{FS}-6.25 \mathrm{~dB} \end{aligned}$ | -55 |  | dBc |
| POWER SUPPLY CHARACTERISTICS |  |  |  |  |  |
| $\mathrm{I}_{\mathrm{A}}$ | Analog Supply Current | DC Input | 25 | 31 | mA (max) |
|  |  | $\mathrm{f}_{\text {IN }}=10 \mathrm{MHz}, \mathrm{V}_{\text {IN }}=\mathrm{FS}-3 \mathrm{~dB}$ | 25 |  | mA |
| DR $I_{\text {D }}$ | Output Driver Supply Current | DC Input | 0.3 | 1 | mA (max) |
|  |  | $\mathrm{f}_{\mathrm{IN}}=10 \mathrm{MHz}, \mathrm{V}_{\mathrm{IN}}=\mathrm{FS}-3 \mathrm{~dB}$ | 4.4 |  | mA |
| $\begin{aligned} & \mathrm{I}_{\mathrm{A}}+ \\ & \mathrm{DRI}_{\mathrm{D}} \end{aligned}$ | Total Operating Current | DC Input | 25.3 | 32 | mA (max) |
|  |  | $\begin{aligned} & \mathrm{f}_{\mathrm{IN}}=10 \mathrm{MHz}, \mathrm{~V}_{\mathrm{IN}}=\mathrm{FS}-3 \mathrm{~dB}, \\ & \mathrm{PD}=\text { Low } \end{aligned}$ | 29.4 |  | mA (max) |
|  |  | CLK Low, PD = Hi | 0.2 |  |  |

## Converter Electrical Characteristics (Continued)

The following specifications apply for $\mathrm{V}_{\mathrm{A}}=\mathrm{DR} \mathrm{V}_{\mathrm{D}}=+3.0 \mathrm{~V}_{\mathrm{DC}}, \mathrm{V}_{\mathrm{RT}}=+1.9 \mathrm{~V}, \mathrm{~V}_{\mathrm{RB}}=0.3 \mathrm{~V}, \mathrm{C}_{\mathrm{L}}=10 \mathrm{pF}, \mathrm{f}_{\mathrm{CLK}}=60 \mathrm{MHz}$ at $50 \%$ duty cycle. Boldface limits apply for $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\text {MII }}$ to $\mathrm{T}_{\text {MAX }}$ : all other limits $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (Notes 7, 8)

| Symbol | Parameter | Conditions | Typical (Note 9) | Limits (Note 9) | Units (Limits) |
| :---: | :---: | :---: | :---: | :---: | :---: |
| POWER SUPPLY CHARACTERISTICS |  |  |  |  |  |
| PC | Power Consumption | DC Input | 76 | 96 | mW (max) |
|  |  | $\begin{aligned} & \mathrm{f}_{\mathrm{IN}}=10 \mathrm{MHz}, \mathrm{~V}_{\mathrm{IN}}=\mathrm{FS}-3 \mathrm{~dB}, \\ & \mathrm{PD}=\text { Low } \end{aligned}$ | 88 |  | mW |
|  |  | CLK Low, PD = Hi | 0.6 |  | mW |
| $\mathrm{PSRR}_{1}$ | Power Supply Rejection Ratio | FSE change with 2.7 V to 3.3 V change in $V_{A}$ | 54 |  | dB |
| $\mathrm{PSRR}_{2}$ | Power Supply Rejection Ratio | SNR change with 200 mV at 200 kHz on supply | 45 |  | dB |

AC ELECTRICAL CHARACTERISTICS

| $\mathrm{f}_{\mathrm{C} 1}$ | Maximum Conversion Rate |  | 70 | $\mathbf{6 0}$ | $\mathrm{MHz}(\mathbf{m i n})$ |
| :--- | :--- | :--- | :---: | :---: | :---: |
| $\mathrm{f}_{\mathrm{C} 2}$ | Minimum Conversion Rate |  | 20 |  | MHz |
| $\mathrm{t}_{\mathrm{CL}}$ | Minimum Clock Low Time |  |  | $\mathbf{6 . 7}$ | $\mathrm{ns}(\mathrm{min})$ |
| $\mathrm{t}_{\mathrm{CH}}$ | Minimum Clock High Time |  |  | $\mathbf{6 . 7}$ | $\mathrm{ns}(\mathrm{min})$ |
| $\mathrm{t}_{\mathrm{OH}}$ | Output Hold Time | CLK Rise to Data Invalid | 4.4 |  | ns |
| $\mathrm{t}_{\mathrm{OD}}$ | Output Delay | CLK Rise to Data Valid | 8.2 | $\mathbf{1 2}$ | $\mathrm{~ns}(\mathrm{max})$ |
|  | Pipeline Delay (Latency) |  | 2.5 |  | Clock Cycles |
| $\mathrm{t}_{\mathrm{AD}}$ | Sampling (Aperture) Delay | CLK Fall to Acquisition of Data | 1.5 |  | ns |
| $\mathrm{t}_{\mathrm{AJ}}$ | Aperture Jitter |  | 2 |  | ps rms |

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics. The guaranteed specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.
Note 2: All voltages are measured with respect to GND $=A G N D=D R G N D=O V$, unless otherwise specified.
Note 3: When the input voltage at any pin exceeds the power supplies (that is, less than AGND or DR GND, or greater than $V_{A}$ or $D R V_{D}$ ), the current at that pin should be limited to 25 mA . The 50 mA maximum package input current rating limits the number of pins that can safely exceed the power supplies with an input current of 25 mA to two.
Note 4: The absolute maximum junction temperature ( $T_{\jmath} \max$ ) for this device is $150^{\circ} \mathrm{C}$. The maximum allowable power dissipation is dictated by $\mathrm{T}_{\mathrm{J}} \mathrm{max}$, the junction-to-ambient thermal resistance $\left(\theta_{\mathrm{JA}}\right)$, and the ambient temperature $\left(\mathrm{T}_{\mathrm{A}}\right)$, and can be calculated using the formula $\mathrm{P}_{\mathrm{D}} \mathrm{MAX}=\left(\mathrm{T}_{\mathrm{J}} \mathrm{max}-\mathrm{T}_{\mathrm{A}}\right) / \theta_{\mathrm{JA}}$. In the $24-\mathrm{pin}$ TSSOP, $\theta_{\mathrm{JA}}$ is $92^{\circ} \mathrm{C} / \mathrm{W}$, so $\mathrm{P}_{\mathrm{D}} \mathrm{MAX}=1,358 \mathrm{~mW}$ at $25^{\circ} \mathrm{C}$ and 435 mW at the maximum operating ambient temperature of $85^{\circ} \mathrm{C}$. Note that the power consumption of this device under normal operation will typically be about 180 mW ( 88 mW quiescent power +12 mW reference ladder power). The values for maximum power dissipation listed above will be reached only when the ADC08060 is operated in a severe fault condition (e.g., when input or output pins are driven beyond the power supply voltages, or the power supply polarity is reversed). Obviously, such conditions should always be avoided.
Note 5: Human body model is 100 pF capacitor discharged through a $1.5 \mathrm{k} \Omega$ resistor. Machine model is 220 pF discharged through ZERO Ohms.
Note 6: See AN-450, "Surface Mounting Methods and Their Effect on Product Reliability", or the section entitled "Surface Mount" found in any post 1986 National Semiconductor Linear Data Book, for other methods of soldering surface mount devices.
Note 7: The analog inputs are protected as shown below. Input voltage magnitudes up to $\mathrm{V}_{\mathrm{A}}+300 \mathrm{mV}$ or to 300 mV below GND will not damage this device. However, errors in the $A / D$ conversion can occur if the input goes above $D R V_{D}$ or below $G N D$ by more than 100 mV . For example, if $V_{A}$ is $2.7 \mathrm{~V}_{\mathrm{DC}}$ the full-scale input voltage must be $\leq 2.6 \mathrm{~V}_{\mathrm{DC}}$ to ensure accurate conversions.


Note 8: To guarantee accuracy, it is required that $V_{A}$ and $D R V_{D}$ be well bypassed. Each supply pin must be decoupled with separate bypass capacitors.
Note 9: Typical figures are at $\mathrm{T}_{J}=25^{\circ} \mathrm{C}$, and represent most likely parametric norms. Test limits are guaranteed to National's AOQL (Average Outgoing Quality Level).

Typical Performance Characteristics $\mathrm{V}_{\mathrm{A}}=\mathrm{DR} \mathrm{V}_{\mathrm{D}}=3 \mathrm{~V}, \mathrm{f}_{\mathrm{CLK}}=60 \mathrm{MHz}, \mathrm{f}_{\text {IN }}=10 \mathrm{MHz}$, unless otherwise stated

INL


20006208
INL vs Supply Voltage


20006215
DNL


INL vs Temperature


INL vs Sample Rate


Typical Performance Characteristics $\mathrm{V}_{\mathrm{A}}=\mathrm{DR} \mathrm{V}_{\mathrm{D}}=3 \mathrm{~V}, \mathrm{f}_{\mathrm{CLK}}=60 \mathrm{MHz}$, $\mathrm{f}_{\mathrm{IN}}=10 \mathrm{MHz}$, unless otherwise stated (Continued)


SNR vs Temperature


20006220


DNL vs Sample Rate


SNR vs Supply Voltage


20006221

SNR vs Input Frequency


Typical Performance Characteristics $\mathrm{V}_{\mathrm{A}}=\mathrm{DR} \mathrm{V}_{\mathrm{D}}=3 \mathrm{~V}, \mathrm{f}_{\mathrm{CLK}}=60 \mathrm{MHz}, \mathrm{f}_{\mathrm{IN}}=10 \mathrm{MHz}$, unless otherwise stated (Continued)



20006226



## Distortion vs Sample Rate



20006213

## Distortion vs Clock Duty Cycle



Typical Performance Characteristics $\mathrm{V}_{\mathrm{A}}=\mathrm{DR} \mathrm{V}_{\mathrm{D}}=3 \mathrm{~V}, \mathrm{f}_{\mathrm{CLK}}=60 \mathrm{MHz}$, $\mathrm{f}_{\mathrm{IN}}=10 \mathrm{MHz}$, unless otherwise stated (Continued)


20006230
SINAD/ENOB vs Sample Rate


20006216

## SINAD/ENOB vs Clock Duty Cycle




## SINAD/ENOB vs Input Frequency



20006239


Typical Performance Characteristics $\mathrm{V}_{\mathrm{A}}=\mathrm{DR} \mathrm{V}_{\mathrm{D}}=3 \mathrm{~V}, \mathrm{f}_{\mathrm{CLK}}=60 \mathrm{MHz}, \mathrm{f}_{\mathrm{IN}}=10 \mathrm{MHz}$, unless otherwise stated (Continued)



Intermodulation Distortion (IMD)


## Specification Definitions

APERTURE (SAMPLING) DELAY is that time required after the fall of the clock input for the sampling switch to open. The Sample/Hold circuit effectively stops capturing the input signal and goes into the "hold" mode $t_{A D}$ after the clock goes low.
APERTURE JITTER is the variation in aperture delay from sample to sample. Aperture jitter shows up as noise at the output.
CLOCK DUTY CYCLE is the ratio of the time that the clock wavesform is at a logic high to the total time of one clock period.
DIFFERENTIAL NON-LINEARITY (DNL) is the measure of the maximum deviation from the ideal step size of 1 LSB. Measured at 60 MSPS with a ramp input.
EFFECTIVE NUMBER OF BITS (ENOB, or EFFECTIVE BITS) is another method of specifying Signal-to-Noise and Distortion Ratio, or SINAD. ENOB is defined as (SINAD 1.76) / 6.02 and says that the converter is equivalent to a perfect ADC of this (ENOB) number of bits.
FULL-POWER BANDWIDTH is the frequency at which the reconstructed output fundamental drops 3 dB below its low frequency value for a full scale input.
FULL-SCALE ERROR is a measure of how far the last code transition is from the ideal $11 / 2$ LSB below $V_{R T}$ and is defined as:

$$
\mathrm{V}_{\max }+1.5 \mathrm{LSB}-\mathrm{V}_{\mathrm{RT}}
$$

where $\mathrm{V}_{\text {max }}$ is the voltage at which the transition to the maximum (full scale) code occurs.
INTEGRAL NON-LINEARITY (INL) is a measure of the deviation of each individual code from a line drawn from zero scale ( $1 / 2$ LSB below the first code transition) through positive full scale ( $1 / 2$ LSB above the last code transition). The deviation of any given code from this straight line is measured from the center of that code value. The end point test method is used. Measured at 60 MSPS with a ramp input.
INTERMODULATION DISTORTION (IMD) is the creation of additional spectral components as a result of the interaction between two sinusoidal frequencies that are applied to the ADC input at the same time. IMD is the ratio of the power in the second and third order intermodulation products to the total power in the original frequencies.
MISSING CODES are those output codes that are skipped and will never appear at the ADC outputs. These codes cannot be reached with any input value.
POWER SUPPLY REJECTION RATIO (PSRR) is a measure of how well the ADC rejects a change in the power supply voltage. For the ADC08060, PSRR1 is the ratio of the change in dc power supply voltage to the resulting change in Full-Scale Error, expressed in dB. PSRR2 is a measure of
how well an a.c. signal riding upon the power supply is rejected and is here defined as:

$$
\operatorname{PSRR} 2=20 \log \left(4 \sqrt{10^{\frac{-S N R 1}{10}}-10^{\frac{-S N R 0}{10}}}\right)
$$

where SNRO is the SNR measured with no noise or signal on the supply lines and SNR1 is the SNR measured with a 200 $\mathrm{kHz}, 200 \mathrm{mV} \mathrm{P}_{\text {P-p }}$ signal riding upon the supply lines.
OUTPUT DELAY is the time delay after the rising edge of the input clock before the data changes at the output pins.
OUTPUT HOLD TIME is the length of time that the output data is valid after the rise of the input clock.
PIPELINE DELAY (LATENCY) is the number of clock cycles between initiation of conversion and when that data is presented to the output driver stage. New data is available at every clock cycle, but the data lags the conversion by the Pipeline Delay plus the Output Delay.
SIGNAL TO NOISE RATIO (SNR) is the ratio, expressed in dB , of the rms value of the input signal frequency at the output to the rms value of the sum of all other spectral components below one-half the sampling frequency, not including harmonics or dc.
SIGNAL TO NOISE PLUS DISTORTION (S/(N+D) or SINAD) is the ratio, expressed in dB , of the rms value of the input signal frequency at the output to the rms value of all of the other spectral components below half the clock frequency, including harmonics but excluding dc.
SPURIOUS FREE DYNAMIC RANGE (SFDR) is the difference, expressed in dB , between the rms values of the input signal frequency at the output and the peak spurious signal, where a spurious signal is any signal present in the output spectrum that is not present at the input.
TOTAL HARMONIC DISTORTION (THD) is the ratio, expressed in dB , of the total of the first nine harmonic levels at the output to the level of the fundatmental at the output. THD is calculated as
$T H D=20 \times \log \sqrt{\frac{f_{2}{ }^{2}+f_{3}{ }^{2}+f_{4}{ }^{2}+f_{5}{ }^{2}+f_{6}{ }^{2}+f_{7}{ }^{2}+f_{8}{ }^{2}+f_{9}{ }^{2}+f_{10}{ }^{2}}{f_{1}{ }^{2}}}$
where $f_{1}$ is the RMS power of the fundamental (input) frequency and $f_{2}$ through $f_{10}$ is the power in the first 9 harmonics in the output spectrum.
ZERO SCALE OFFSET ERROR is the error in the input voltage required to cause the first code transition. It is defined as

$$
V_{\mathrm{OFF}}=\mathrm{V}_{\mathrm{ZT}}-\mathrm{V}_{\mathrm{RB}}
$$

where $\mathrm{V}_{\mathrm{ZT}}$ is the first code transition input voltage.

## Functional Description

The ADC08060 uses a new, unique architecture that achieves over 7.4 effective bits at input frequencies up to 30 MHz .
The analog input signal that is within the voltage range set by $\mathrm{V}_{\mathrm{RT}}$ and $\mathrm{V}_{\mathrm{RB}}$ is digitized to eight bits. Output format is straight binary. Input voltages below $\mathrm{V}_{\mathrm{RB}}$ will cause the output word to consist of all zeroes. Input voltages above $\mathrm{V}_{\mathrm{RB}}$ will cause the output word to consist of all ones.
Incorporating a switched capacitor bandgap, the ADC08060 exhibits a power consumption that is proportional to frequency, limiting power consumption to what is needed at the clock rate that is used. This and its excellent performance over a wide range of clock frequencies makes it an ideal choice as a single ADC for many 8-bit needs.
Data is acquired at the falling edge of the clock and the digital equivalent of that data is available at the digital outputs 2.5 clock cycles plus $t_{\text {OD }}$ later. The ADC08060 will
convert as long as the clock signal is present. The device is in the active state when the Power Down pin (PD) is low. When the PD pin is high, the device is in the power down mode, where the output pins hold the last conversion before the PD pin went high and the device consumes just 1 mW .

## Applications Information

### 1.0 REFERENCE INPUTS

The reference inputs $\mathrm{V}_{\mathrm{RT}}$ and $\mathrm{V}_{\mathrm{RB}}$ are the top and bottom of the reference ladder, respectively. Input signals between these two voltages will be digitized to 8 bits. External voltages applied to the reference input pins should be within the range specified in the Operating Ratings table ( 1.0 V to $\left(\mathrm{V}_{\mathrm{A}}+\right.$ 0.1 V ) for $\mathrm{V}_{\mathrm{RT}}$ and 0 V to ( $\mathrm{V}_{\mathrm{RT}}-1.0 \mathrm{~V}$ ) for $\mathrm{V}_{\mathrm{RB}}$ ). Any device used to drive the reference pins should be able to source sufficient current into the $\mathrm{V}_{\mathrm{RT}}$ pin and sink sufficient current from the $\mathrm{V}_{\mathrm{RB}} \mathrm{pin}$.


FIGURE 2. Simple, low component count reference biasing. Because of the ladder and external resistor tolerances, the reference voltage can vary too much for some applications.

The reference bias circuit of Figure 2 is very simple and the performance is adequate for many applications. However, circuit tolerances will lead to a wide reference voltage range. Superior performance can generally be achieved by driving the reference pins with a low impedance source.
The circuit of Figure 3 will allow a more accurate setting of the reference voltages. The lower amplifier must have bipolar supplies as its output voltage must go negative to force $\mathrm{V}_{\mathrm{RB}}$ to any voltage below the $\mathrm{V}_{\mathrm{BE}}$ of the PNP transistor. Of course, the divider resistors at the amplifier input could be
changed to suit your reference voltage needs, or the divider can be replaced with potentiometers for precise settings. The bottom of the ladder ( $\mathrm{V}_{\mathrm{RB}}$ ) may simply be returned to ground if the minimum input signal excursion is 0 V . Be sure that the driving sources can source sufficient current into the $\mathrm{V}_{\mathrm{RT}}$ pin and sink enough current from the $\mathrm{V}_{\mathrm{RB}}$ pin to keep these pins stable.
The LMC662 amplifier shown was chosen for its low offset voltage and low cost.

$\mathrm{V}_{\mathrm{RT}}$ should always be at least 1.0 V more positive than $\mathrm{V}_{\mathrm{RB}}$ to minimize noise.
$\mathrm{V}_{\mathrm{RM}}$ (pin 9) is the center of the reference ladder and should be bypassed to a clean, quiet point in the analog ground plane with a $0.1 \mu \mathrm{~F}$ capacitor. DO NOT allow this pin to float.

### 2.0 THE ANALOG INPUT

The analog input of the ADC08060 is a switch followed by an integrator. The input capacitance changes with the clock level, appearing as 3 pF when the clock is low, and 4 pF when the clock is high. Since a dynamic capacitance is more
difficult to drive than is a fixed capacitance, choose an amplifier that can drive this type of load. The LMH6702 has been found to be a good amplifier to drive the ADC08060.
Figure 4 shows an example of an input circuit using the LMH6702. Any input amplifier should incorporate some gain as operational amplifiers exhibit better phase margin and transient response with gains above 2 or 3 than with unity gain. If an overall gain of less than 3 is required, attenuate the input and operate the amplifier at a higher gain, as shown in Figure 4.

## Applications Information (Continued)



FIGURE 4. The input amplifier should incorporate some gain for best performance (see text).

The RC at the amplifier output filters the clock rate energy that comes out of the analog input due to the input sampling circuit. The optimum time constant for this circuit depends not only upon the amplifier and ADC, but also on the circuit layout and board material. A resistor value should be chosen between $18 \Omega$ and $47 \Omega$ and the capacitor value chose according to the formula

$$
C=\frac{1}{2 \cdot \pi \cdot R \cdot f_{C L K}}
$$

This will provide optimum SNR performance. Best THD performance is realized when the capacitor and resistor values are both zero. To optimize SINAD, reduce the capacitor value until SINAD performance is optimized. That is, until SNR $=-$ THD. This value will usually be in the range of $40 \%$ to $65 \%$ of the value calculated with the above formula. An accurate calculation is not possible because of the board material and layout dependance.
The above is indended for oversampling or Nyquist applications. There should be no resistor or capacitor between the ADC input and any amplifier for undersampling applications.
The circuit of Figure 4 has both gain and offset adjustments. If you eliminate these adjustments normal circuit tolerances may cause signal clipping unless care is exercised in the worst case analysis of component tolerances and the input signal excursion is appropriately limited to account for the worst case conditions. Of course, this means that the designer will not be able to count on getting a full scale output with maximum signal input.

### 3.0 POWER SUPPLY CONSIDERATIONS

A/D converters draw sufficient transient current to corrupt their own power supplies if not adequately bypassed. A $10 \mu \mathrm{~F}$ tantalum or aluminum electrolytic capacitor should be placed within an inch $(2.5 \mathrm{~cm})$ of the A/D power pins, with a $0.1 \mu \mathrm{~F}$ ceramic chip capacitor placed within one centimeter of the converter's power supply pins. Leadless chip capacitors are preferred because they have low lead inductance.
While a single voltage source is recommended for the $\mathrm{V}_{\mathrm{A}}$ and $D R V_{D}$ supplies of the ADC08060, these supply pins should be well isolated from each other to prevent any digital noise from being coupled into the analog portions of the ADC. A choke or $27 \Omega$ resistor is recommended between these supply lines with adequate bypass capacitors close to the supply pins.
As is the case with all high speed converters, the ADC08060 should be assumed to have little power supply rejection. None of the supplies for the converter should be the supply that is used for other digital circuitry in any system with a lot of digital power being consumed. The ADC supplies should be the same supply used for other analog circuitry.
No pin should ever have a voltage on it that is in excess of the supply voltage or below ground by more than 300 mV , not even on a transient basis. This can be a problem upon application of power and power shut-down. Be sure that the supplies to circuits driving any of the input pins, analog or digital, do not come up any faster than does the voltage at the ADC08060 power pins.

## Applications Information

(Continued)

### 4.0 THE DIGITAL INPUT PINS

The ADC08060 has two digital input pins: The PD pin and the Clock pin.

### 4.1 The PD Pin

The Power Down (PD) pin, when high, puts the ADC08060 into a low power mode where power consumption is reduced to 1 mW . Output data is valid and accurate about 1 millisecond after the PD pin is brought low.
The digital output pins retain the last conversion output code when either the clock is stopped or the PD pin is high.

### 4.2 The ADC08060 Clock

Although the ADC08060 is tested and its performance is guaranteed with a 60 MHz clock, it typically will function well with clock frequencies from 20 MHz to 70 MHz .
Halting the clock will provide nearly as much power saving as raising the PD pin high. Typical power consumption with a stopped clock is 3 mW , compared to 1 mW when PD is high. The digital outputs will remain in the same state as they were before the clock was halted.
Once the clock is restored (or the PD pin is brought low), there is a time of 2.5 clock cycles plus $t_{\text {OD }}$ before the output data is valid. However, because of the linear relationship between total power consumption and clock frequency, the part requires several microseconds after the clock is restarted or substantially changed in frequency before the part returns to its specified accuracy.
The low and high times of the clock signal can affect the performance of any A/D Converter. Because achieving a precise duty cycle is difficult, the ADC08060 is designed to maintain performance over a range of duty cycles. While it is specified and performance is guaranteed with a $50 \%$ clock duty cycle and 60 Msps , ADC08060 performance is typically maintained with clock high and low times of 6.7 ns , corresponding to a clock duty cycle range of $40 \%$ to $50 \%$ with a 60 MHz clock.
The CLOCK line should be series terminated at the clock source in the characteristic impedance of that line. If the clock line is longer than

$$
\frac{t_{r}}{6 \times t_{P D}}
$$

where $t_{r}$ is the clock rise time and $t_{P D}$ is the propagation rate of the signal along the trace, the CLOCK pin should be a.c. terminated with a series RC to ground such that the resistor value is equal to the characteristic impedance of the clock line and the capacitor value is

$$
C \geq \frac{4 \times t_{P D} \times L}{Z_{o}}
$$

where $t_{P D}$ is the signal propagation rate down the clock line, " $L$ " is the line length and $Z_{o}$ is the characteristic impedance of the clock line. This termination should be located as close as possible to, but within one centimeter of, the ADC08060 clock pin. Typical $t_{P D}$ is about 150 ps/inch on FR-4 board material. For FR-4 board material, the value of $C$ becomes

$$
C \geq \frac{6 \times 10^{-10} \times L}{Z_{0}}
$$

where $L$ is the length of the clock line in inches.

### 5.0 LAYOUT AND GROUNDING

Proper grounding and proper routing of all signals are essential to ensure accurate conversion. A combined analog and digital ground plane should be used.
Since digital switching transients are composed largely of high frequency components, total ground plane copper weight will have little effect upon the logic-generated noise because of the skin effect. Total surface area is more important than is total ground plane volume. Capacitive coupling between the typically noisy digital circuitry and the sensitive analog circuitry can lead to poor performance that may seem impossible to isolate and remedy. The solution is to keep the analog circuitry well separated from the digital circuitry.
High power digital components should not be located on or near a straight line between the ADC (or any linear component) and the power supply area as the resulting common return current path could cause fluctuation in the analog "ground" return of the ADC.
Generally, analog and digital lines should cross each other at $90^{\circ}$ to avoid getting digital noise into the analog path. In high frequency systems, however, avoid crossing analog and digital lines altogether. Clock lines should be isolated from ALL other lines, analog AND digital. Even the generally accepted $90^{\circ}$ crossing should be avoided as even a little coupling can cause problems at high frequencies. Best performance at high frequencies is obtained with a straight signal path.
The analog input should be isolated from noisy signal traces to avoid coupling of spurious signals into the input. Any external component (e.g., a filter capacitor) connected between the converter's input and ground should be connected to a very clean point in the analog ground plane.


FIGURE 5. Layout Example

## Applications Information (Continued)

Figure 5 gives an example of a suitable layout. All analog circuitry (input amplifiers, filters, reference components, etc.) should be placed together away from any digital components.

### 6.0 DYNAMIC PERFORMANCE

The ADC08060 is ac tested and its dynamic performance is guaranteed. To meet the published specifications, the clock source driving the CLK input must exhibit less than 10 ps (rms) of jitter. For best ac performance, isolating the ADC clock from any digital circuitry should be done with adequate buffers, as with a clock tree. See Figure 6.
It is good practice to keep the ADC clock line as short as possible and to keep it well away from any other signals. Other signals can introduce jitter into the clock signal. The clock signal can also introduce noise into the analog path.


FIGURE 6. Isolating the ADC Clock from Digital Circuitry

### 7.0 COMMON APPLICATION PITFALLS

Driving the inputs (analog or digital) beyond the power supply rails. For proper operation, all inputs should not go more than 300 mV below the ground pins or 300 mV above the supply pins. Exceeding these limits on even a transient
basis may cause faulty or erratic operation. It is not uncommon for high speed digital circuits (e.g., 74F and 74AC devices) to exhibit undershoot that goes more than a volt below ground. A $51 \Omega$ resistor in series with the offending digital input will usually eliminate the problem.
Care should be taken not to overdrive the inputs of the ADC08060. Such practice may lead to conversion inaccuracies and even to device damage.
Attempting to drive a high capacitance digital data bus. The more capacitance the output drivers must charge for each conversion, the more instantaneous digital current is required from DR $V_{D}$ and DR GND. These large charging current spikes can couple into the analog section, degrading dynamic performance. Buffering the digital data outputs (with a 74F541, for example) may be necessary if the data bus capacitance exceeds 10 pF . Dynamic performance can also be improved by adding $47 \Omega$ to $56 \Omega$ series resistors at each digital output, reducing the energy coupled back into the converter input pins.
Using an inadequate amplifier to drive the analog input. As explained in Section 2.0, the capacitance seen at the input alternates between 3 pF and 4 pF with the clock. This dynamic capacitance is more difficult to drive than is a fixed capacitance, and should be considered when choosing a driving device. The LMH6702 has been found to be a good device for driving the ADC08060.
Driving the $\mathrm{V}_{\mathrm{RT}}$ pin or the $\mathrm{V}_{\mathrm{RB}}$ pin with devices that can not source or sink the current required by the ladder. As mentioned in Section 1.0, care should be taken to see that any driving devices can source sufficient current into the $\mathrm{V}_{\mathrm{RT}}$ pin and sink sufficient current from the $\mathrm{V}_{\mathrm{RB}}$ pin. If these pins are not driven with devices than can handle the required current, these reference pins will not be stable, resulting in a reduction of dynamic performance.
Using a clock source with excessive jitter, using an excessively long clock signal trace, or having other signals coupled to the clock signal trace. This will cause the sampling interval to vary, causing excessive output noise and a reduction in SNR performance. The use of simple gates with RC timing is generally inadequate as a clock source.

Physical Dimensions inches (millimeters) unless otherwise noted


NOTES: UNLESS OTHERWISE SPECIFIED
REFERENCE JECED REGISTRATION mo-153, VARIATION AD, DATED 7/93.
24-Lead Package TC Order Number ADC08060CIMT NS Package Number MTC24

## LIFE SUPPORT POLICY

NATIONAL'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT AND GENERAL COUNSEL OF NATIONAL SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.

| National Semiconductor | National Semiconductor | National Semiconductor | National Semiconductor |
| :--- | :--- | :--- | :--- |
| Americas Customer | Europe Customer Support Center | Asia Pacific Customer | Japan Customer Support Center |
| Support Center | Fax: $+49(0) 180-5308586$ | Support Center | Fax: $81-3-5639-7507$ |
| Email: new.feedback@nsc.com | Email: europe.support@nsc.com | Fax: $65-62504466$ | Email: nsj.crc@jksmtp.nsc.com |
| Tel: $1-800-272-9959$ | Deutsch Tel: $+49(0) 6995086208$ | Email: ap.support@nsc.com | Tel: 81-3-5639-7560 |
| www.national.com | English Tel: $+44(0) 8702402171$ | Tel: $65-62544466$ |  |
|  | Français Tel: $+33(0) 141918790$ |  |  |
|  |  |  |  |

National does not assume any responsibility for use of any circuitry described, no circuit patent licenses are implied and National reserves the right at any time without notice to change said circuitry and specifications.

